

#### 1A Bipolar Linear Regulator

# LR1117C

#### **DESCRIPTION**

LR1117C is a series of low dropout three terminal regulators with a dropout of 1.3V at 1A load current. LR1117C features a very low standby current 2mA compared to 5mA of competitor.

Other than a fixed version, Vout = 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, 5V, and 12V, LR1117C has an adjustable version, which can provide an output voltage from 1.25 to 12V with only two external resistors.

LR1117C offers thermal shut down and current limit functions, to assure the stability of chip and power system. And it uses trimming technique to guarantee output voltage accuracy within  $\pm 2\%$ . Other output voltage accuracy can be customized on demand, such as  $\pm 1\%$ 

LR1117C is available in SOT223 and TO-252 (DPAK) power packages.

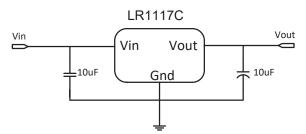
#### **FEATURES**

- Other than a fixed version and an adjustable version, output value can be customized on demand.
- Maximum output current is 1A
- Range of operation input voltage: Max 15V
- Standby current: 2mA (typ.)Line regulation: 0.1%/V (typ.)
- Load regulation: 10mV (typ.)
- Environment Temperature: -40°C~85°C

#### **APPLICATIONS**

- Power Management for Computer Mother Board, Graphic Card
- BLD Monitor and BLD TV
- DVD Decode Board
- ADSL Moderm
- Post Regulators for Switching Supplies

#### **TYPICAL APPLICATION**



Application circuit of LR1117C fixed version

NOTE: Input capacitor (Cin=10uF) and Output capacitor (Cout=10uF) are recommended in all application circuit. Tantalum capacitor is recommended.

#### TYPICAL ELECTRICAL CHARACTERISTIC

#### 1.4 1.2 1 0.8 0.6 0.4 0.2

Temperature (°C)

150

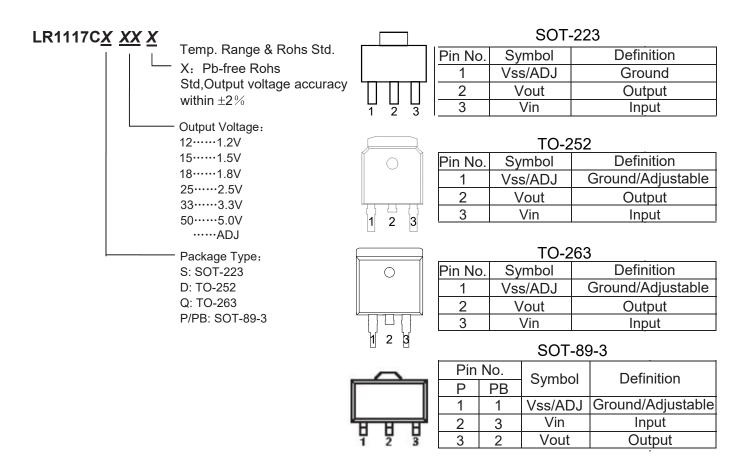
LR1117C-ADJ Vout Vs. Temp

Ver2.4 1/14



#### ORDERING INFORMATION

#### **PIN CONFIGURATION**



#### **ABSOLUTE MAXIMUM RATING**

Parameter	Value
Max Input Voltage	18V <sup>⊕</sup>
Max Operating Junction Temperature(Tj)	150°C
Ambient Operating Temperature(Ta)	-40°C - 85°C
Storage Temperature(Ts)	-40°C - 150°C
Lead Temperature & Time	260°C, 10S

Note: Exceeding these limits will cause damage to the device. Exposure to absolute maximum rating conditions may affect device reliability.

#### **RECOMMENDED WORK CONDITIONS**

Parameter		Value
Input Voltage Range		Max. 15V
Operating Junction Temperature(Tj)		-40"C -125"C
Thermal resistance <sup>③</sup>	SOT-223	25"C/W
- Junction to Case	TO-252	10"C/W
Thermal resistance <sup>②</sup>	SO-T223	136"C/W
- Junction to Ambient (No air flow)	TO-252	105"C/W

Note: 1.Rθja Test conditions:The device mounted on 42.25mm2(Pin2) FR-4 board with 2oz. Copper

$$2.\,P_D = \frac{T_J(max) - T_A}{R_{\theta JA}}$$

Ver2.4



# **ELECTRICAL CHARACTERISTICS**

Ti=25°C

Symbol	Parameter	Conditions	Min	Tvn	Max	Tj=25°C Unit
Зуппрог	Parameter	LR1117C-ADJ	IVIIII	Тур	IVIAX	Ullit
Vref	Reference Voltage	10mA≤lout≤1A , Vin=3.25V	1.225	1.25	1.275	V
		LR1117C-1.2V				
		0≤lout≤1A , Vin=3.2V	1.176	1.2	1.224	V
		LR1117C-1.5V	1.47	4.5	1.52	
		0≤lout≤1A , Vin=3.5V	1.47	1.5	1.53	V
		LR1117C-1.8V	1.764	1.8	1.836	V
		0≤lout≤1A , Vin=3.8V	1.701	1.0	1.050	•
Vout	Output Voltage	LR1117C-2.5V	2.45	2.5	2.55	V
		0≤lout≤1A , Vin=4.5V				
		LR1117C-3.3V 0≤lout≤1A , Vin=5.3V	3.234	3.3	3.366	V
		LR1117C-5.0V				
		0≤lout≤1A , Vin=7.0V	4.9	5	5.1	V
		LR1117C-12.0V	44.76	42	42.24	
		0≤lout≤1A , Vin=14V	11.76	12	12.24	V
		LR1117C-1.2V		0.1	0.2	%/V
		lout=10mA, 2.7V≤Vin≤10V		0.1	0.2	70/ V
		LR1117C-ADJ		0.1	0.2	%/V
		lout=10mA, 2.75V ≤ Vin ≤ 12V			0.2	, , , ,
		LR1117C-1.5V		0.1	0.2	%/V
		out=10mA, 3.0V ≤ Vin ≤ 12V				
		LR1117C-1.8V		0.1	0.2	%/V
A\/a++	Line Regulation	lout=10mA, 3.3V ≤ Vin ≤ 12V				
ΔVout	Line Regulation	LR1117C-2.5V		0.1	0.2	%/V
		lout=10mA, 4.0V ≤ Vin ≤ 12V				
		LR1117C-3.3V		0.1	0.2	%/V
		lout=10mA, 4.8V ≤ Vin ≤ 12V				,
		LR1117C-5.0V		0.1	0.2	%/V
		lout=10mA, 6.5V≤Vin≤12V		0.1	0.2	707 4
		LR1117C-12.0V		0.1	0.2	%/\/
		lout=10mA, 13.5V≤Vin≤20V		0.1		%/V
		LR1117C-1.2V		10	30	m\/
		Vin =2.7V, $10mA \le lout \le 1A$		10 30	mV	
		LR1117C-ADJ		10	20	ma\/
		Vin =2.75V, 10mA≤lout≤1A		10	30	mV
		LR1117C-1.5V		10	30	mV
		Vin=3.0V, 10mA ≤ lout ≤ 1A		10	30	IIIV
		LR1117C-1.8V		10	30	mV
ΔVout Load		Vin=3.3V, $10mA \le lout \le 1A$		10	30	
	Load Regulation	LR1117C-2.5V		10	20	ma\ /
		Vin=4.0V, $10mA \le lout \le 1A$		10	30	mV
		LR1117C-3.3V		40	20	
		Vin=4.8V, $10\text{mA} \le \text{lout} \le 1\text{A}$	10		30	mV
		LR1117C-5.0V				++
		Vin=6.5V, $10\text{mA} \le \text{lout} \le 1\text{A}$		10	30	mV
		LR1117C-12.0V				
				10	30	mV
	1	Vin=13.5V, $10\text{mA} \le \text{lout} \le 1\text{A}$			<u> </u>	

Ver2.4 3/14



#### **ELECTRICAL CHARACTERISTICS continued**

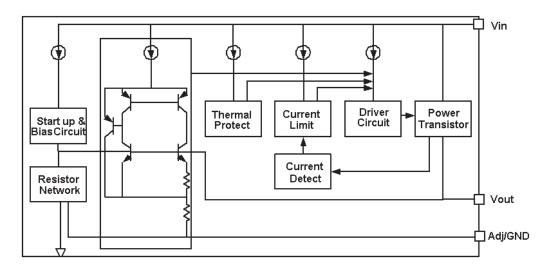
Tj=25°C

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Vd B		lout=100mA		1.23	1.3	V
Vdrop	Dropout Voltage	lout=1A		1.3	1.5	V
Ilimit	Current Limit	Vin-Vout=2V, Tj=25°C	1			А
SVR	Supply Voltage Rejection	f = 120Hz, VIN – VOUT = 3V + 1VPP Ripple		60		dB
Imin	Minimum Load Current	LR1117C-ADJ		2	10	mA
	lq Quiescent Current	LR1117C-1.2V, Vin =10V	1	2	5	mA
		LR1117C-1.5V, Vin =11V	1	2	5	mA
		LR1117C-1.8V, Vin =12V	1	2	5	mA
Iq		LR1117C-2.5V,Vin =12V	1	2	5	mA
		LR1117C-3.3V, Vin =12V	1	2	5	mA
		LR1117C-5.0V, Vin =12V	1	2	5	mA
		LR1117C-12.0V, Vin =20V	1	2	5	mA
IAdj	Adjust Pin Current	LR1117C-ADJ	35	55	120	uA
iAuj	Adjust Fill Culterit	Vin =5V, $10\text{mA} \le \text{lout} \le 1\text{A}$	33		120	
Ichange	ladj change	LR1117C-ADJ		0.2	10	uA
ichange	iaaj alialige	Vin =5V, $10\text{mA} \le \text{lout} \le 1\text{A}$		0.2	10	u, t
ΔV/ΔΤ	Temperature coefficient			±100		ppm

Note1: All test are conducted under ambient temperature 25  $^{\circ}$ C and within a short period of time 20ms

Note2: Load current smaller than minimum load current of LR1117C-ADJ will lead to unstable or oscillation output.

#### **BLOCK DIAGRAM**



Ver2.4 4/14



#### **DETAILED DESCRIPTION**

LR1117C is a series of low dropout voltage, three terminal regulators. Its application circuit is very simple: the fixed version only needs two capacitors and the adjustable version only needs two resistors and two capacitors to work. It is composed of some modules including start-up circuit, bias circuit, bandgap, thermal shutdown, current limit, power transistors and its driver circuit and so on.

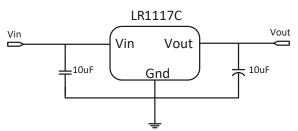
The thermal shut down modules can assure chip and its application system working safety when the junction temperature is larger than 140°C.

The bandgap module provides stable reference voltage, whose temperature coefficient is compensated by careful design considerations. The temperature coefficient is under 100 ppm/°C. And the accuracy of output voltage is guaranteed by trimming technique.

#### TYPICAL APPLICATION

LR1117C has an adjustable version and six fixed versions (1.2V, 1.5V, 1.8V, 2.5V, 3.3V, 5V and 12V)

#### **Fixed Output Voltage Version**

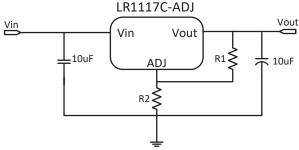


Application circuit of LR1117C fixed version

- 1) Recommend using 10uF tan capacitor or MLCC capacitor as bypass capacitor (C1) for all application circuit.
- 2) Recommend using 10uF tan capacitor MLCC capacitor to assure circuit stability.
- 3) Capacitor ESR range:  $3m\Omega \sim 22\Omega$

#### **Adjustable Output Voltage Version**

LR1117C-ADJ provides a 1.25V reference voltage. Any output voltage between 1.25V~12V can be achievable by choosing two external resistors (schematic is shown below), R1 and R2



Application Circuit of LR1117C-ADJ

The output voltage of adjustable version follows the equation: Vout= $1.25\times(1+R2/R1)+IAdj\times R2$ . We can ignore IAdj because IAdj (about 50uA) is much less than the current of R1 (about  $2^{-10}$ mA).

Ver2.4 5/14



- 1) To meet the minimum load current (>10mA) requirement, R1 is recommended to be 125ohm or lower. As LR1117C-ADJ can keep itself stable at load current about 2mA, R1 is not allowed to be higher than 625ohm.
- 2) Using a bypass capacitor ( $C_{ADJ}$ ) between the ADJ pin and ground can improve ripple rejection. This bypass capacitor prevents ripple from being amplified as the output voltage is increased. The impedance of  $C_{ADJ}$  should be less than R1 to prevent ripple from being amplified. As R1 is normally in the range of  $100\Omega^{\sim}500\Omega$ , the value of  $C_{ADJ}$  should satisfy this equation:  $1/(2\pi \times f_{ripple} \times C_{ADJ}) < R1$ .

#### THERMAL CONSIDERATIONS

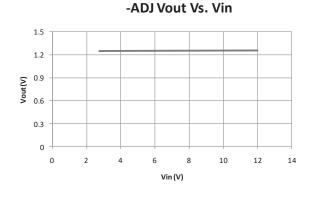
We have to take heat dissipation into great consideration when output current or differential voltage of input and output voltage is large. Because in such cases, the power dissipation consumed by LR1117C series is very large. LR1117C series uses TO-252 (DPAK) package type and its thermal resistance is about 10°C/W. And the copper area of application board can affect the total thermal resistance. If copper area is 5cm\*5cm (two sides), the resistance is about 20°C/W. So the total thermal resistance is about 10°C/W + 20°C/W. We can decrease total thermal resistance by increasing copper area in application board. When there is no good heat dissipation copper are in PCB, the total thermal resistance will be as high as 100°C/W, then the power dissipation of LR1117C series could allow on itself is less than 1W. And furthermore, LR1117C series will work at junction temperature higher than 125°C under such condition and no lifetime is guaranteed.

Ver2.4 6/14

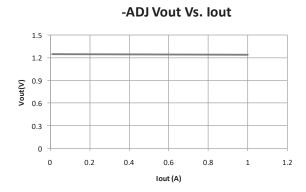


#### PERFORMANCE CHARACTERISTIC CURVES

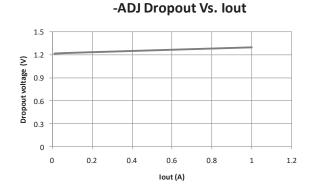
#### **Line Regulation**



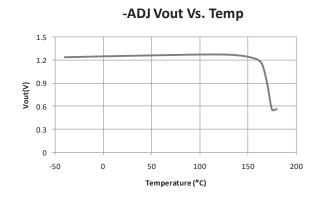
#### **Load Regulation**



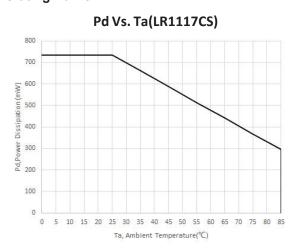
#### **Dropout Voltage**



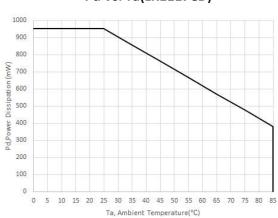
Thermal performance with OTP



#### **Derating Curve**



Pd Vs. Ta(LR1117CD)

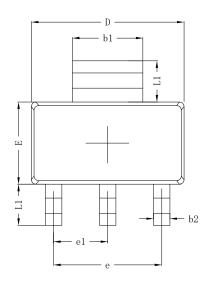


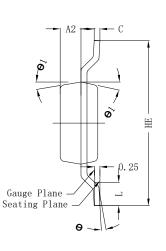
Note: PCBsize: 30.0mm×25.0mm×1.6mm(FR4); Copper Foil Thickness: 35um;

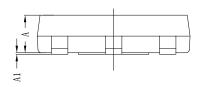
Ver2.4 7/14



#### **SOT-223 PACKAGE OUTLINE DIMENSIONS**





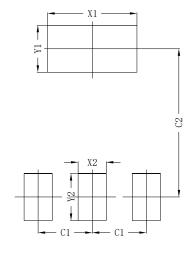


SOT223				
DIM	MIN	NOR	MAX	
А	1.50	1.60	1.70	
A1	0.00	0.05	0.10	
A2	0.80	0.90	1.00	
b1	2.90	3.02	3.10	
b2	0.60	0.72	0.80	
С	0.20	0.27	0.35	
D	6.30	6.50	6.70	
E	3.30	3.50	3.70	
e 4.60BSC				
e1		2.30BSC		
HE	6.80	7.00	7.20	
L	0.80	1.00	1.20	
L1	1.75(REF)			
θ	0°~8°			
θ 1	8°	10°	12°	
All Dimensions in mm				

#### GENERAL NOTES

- 1. Top package surface finish RaO.4 $\pm$ 0.2um
- 2. Bottom package surface finish RaO.7 $\pm$ 0.2um
- 3. Side package surface finish RaO.4 $\pm$ 0.2um
- 4. Protrusion or Gate Burrs shall not exc  $\,\,\mathrm{d}$
- 0.10mm per side.

# Suggested Pad layout

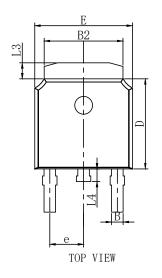


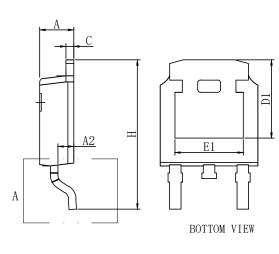
SOT	SOT223			
DIM	(mm)			
X1	3.80			
Y1	2.00			
X2	1.20			
Y2	2.00			
C1	2.30			
C2	6.30			

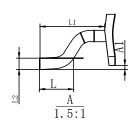
Ver2.4 8/14



# **TO-252-2L PACKAGE OUTLINE DIMENSIONS**

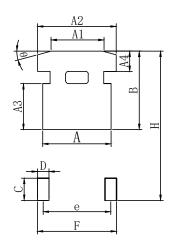






DIM	MILLIMETERS		
Dilvi	MIN	NOM	MAX
Α	2.15	2.30	2.45
A1	0	-	0.20
A2	0.90	1.07	1.17
В	0.68	0.78	0.88
B2	5.20	5.33	5.46
С	0.49	_	0.58
D	5.90	6.10	6.30
D1		5.30REF	
Е	6.40	6.60	6.80
E1	4.63	4.83	5.03
е		2.286BSC	;
Н	9.8	10.10	10.4
L	1.09	1.29	1.49
L1	2.90REF		
L3	0.88	1.08	1.28
L4	0.55	0.80	1.05

Suggested Pad layout

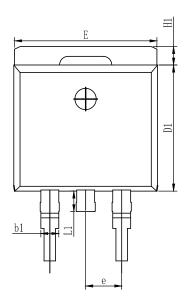


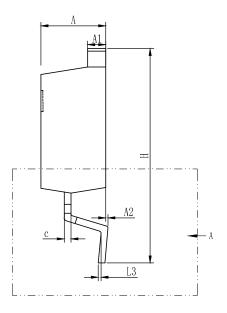
DIM	MIN(mm)
Α	6.03
A1	4.50
A2	6.46
A3	4.10
A4	2.37
В	6.50
С	2.50
D	1.68
е	4.80
Н	12.35
F	5.95

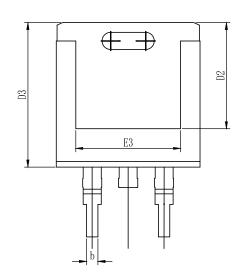
Ver2.4 9/14



# **TO-263-2L PACKAGE OUTLINE DIMENSIONS**







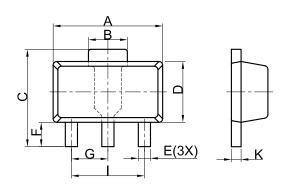


DIM	MI	LLIMETE	RS	
Diivi	MIN	NOM	MAX	
Α	4.42	4.57	4.72	
A1	1.20	1.30	1.40	
A2	0.00	-	0.25	
b	0.73	0.83	0.93	
b1	1.20	1.30	1.40	
С	0.41	0.48	0.58	
D1	8.70	8.90	9.10	
D2	7.20	-	ı	
D3	9.91	10.21	10.51	
Е	9.75	10.05	10.35	
E3	7.10	-	7.70	
е		2.54BSC		
Η	14.84	15.14	15.44	
H1	1.10	1.30	1.50	
Н3	2.35	2.45	2.55	
L	2.18	2.48	2.78	
L1	-	-	1.75	
L2	4.69	4.99	5.29	
L3	0.25BSC			

Ver2.4 10/14



#### **SOT-89-3 PACKAGE OUTLINE DIMENSIONS**



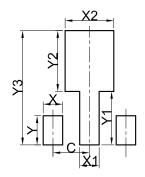


	SOT89				
DIM	MIN	NOR	MAX		
Α	4.30	4.50	4.70		
В	1.40	1.60	1.80		
С	3.90	4.00	4.25		
D	2.30	2.50	2.70		
Е	0.40	0.50	0.58		
F	0.90	1.00	1.20		
G	G 1.50 BSC				
I	3.00 BSC				
J	1.40	1.50	1.60		
K	0.34	0.40	0.50		
	All Dimensions in mm				

#### **GENERAL NOTES**

- 1. Top package surface finish Ra0.4±0.2um
- 2. Bottom package surface finish Ra0.7±0.2um
- 3. Side package surface finish Ra0.4±0.2um
- 4. Protrusion or Gate Burrs shall not exceed 0.10mm per side.

# Suggested Pad layout



SOT89		
DIM	(mm)	
Х	0.80	
Υ	1.20	
X1	0.80	
Y1	2.20	
X2	2.00	
Y2	2.50	
С	1.50	
Y3	4.70	

Ver2.4 11/14

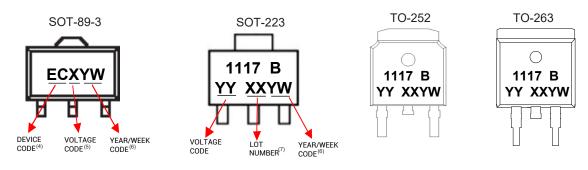


#### **DEVICE MARKING AND REEL INFORMATION**

DEVICE <sup>(1)</sup>	Package	Output Voltage	Marking <sup>(2)(3)</sup>	Shipping
LR1117CSxxX	SOT-223	1.25V~12V	1117 B	2.5K/Reel
LR1117CDxxX	TO-252	1.25V~12V	1117 B	2.5K/Reel
LR1117CQxxX	TO-263	1.25V~12V	1117 B	0.8K/Reel
LR1117CPxxX	SOT-89-3	1.25V~12V	ESX	5K/Reel
LR1117CPBxxX	SOT-89-3	1.25V~12V	ECX	5K/Reel

- (1) The "xx" in part number represents output voltage, eg "18" = 1.8V, "50" = 5.0V, "" (left blank) = ADJ.
- (2) The "X" in the marking changes a long with the output voltage, as figure below.
- (3) There are additional marking, which relates to the date code. For detailed information, please refer to MARKING INFORMATION APPENDIX below.

#### MARKING INFORMATION APPENDIX



- (4) The first two letters in the Marking represent DEVICE CODE.
- (5) The following letter "X" in the Marking changes along with the output voltage, as the chart shows below.

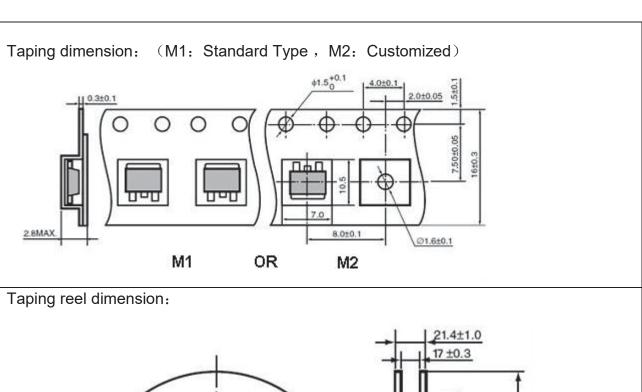
Voltage(V)	•••	1.0	1.2	1.5	1.8	2.5	2.7	2.8	3.0	3.3	3.6	4.0	5.0	12	ADJ	•••
Symbol	•••	D	Е	F	G	Н	I	7	K	Χ	М	Ζ	Р	S	Υ	•••

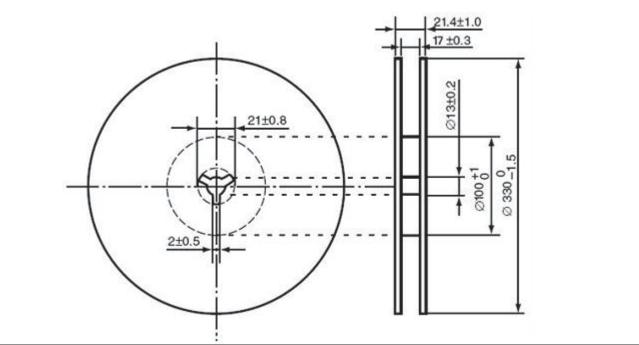
For SOT-223 and TO-252 packages, the VOLTAGE CODE is a two-digit number, eg "18" = 1.8V, "50" = 5.0V, "AD" = Adjustable.

- (6) The last two letters "YW" in the Marking represent YEAR/WEEK CODE.
- (7) The LOT NUMBER is only used for internal production control of the factory.

Ver2.4 12/14







Ver2.4 13/14



# **REVISION HISTORY**

Version	Description	Update by	Update Date
1.6	Update POD; Delete marking information when SOT-223 adjustable Version	Li Song	2022-09-21
1.7	Delete device and marking information about SOT-223 package.	Chen S	2023-01-11
1.8	Add power derating curve; Delete thermal resistance;	Chen S	2023-09-21
1.9	Add device and marking information about SOT-223 package.	Chen S	2023-10-11
2.0	Delete marking information in pin configuration. Add device and marking information about SOT-89-3 package. Add part number information and detailed marking information diagram.	Chen S	2024-06-21
2.1	Change the SOT-89-3 package reel information from 1k/reel to 5k/reel. Change the SOT-223 package reel information from 1k/reel to 2.5k/reel.	Chen S	2024-08-21
2.2	Add device and marking information about TO-263 package.	Chen S	2024-10-11
2.3	Correct device marking for LR1117CPxxX and LR1117CPBxxX.	Chen S	2024-10-29
2.4	Update voltage code in device marking.	Chen S	2025-12-21

Ver2.4 14/14



#### **DISCLAIMER**

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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